LM4130

Precision Current Source Formed With Bootstrapped Integrator



Literature Number: SNVA579

Technology Edge

Republished with permission by Electronic Design

Precision Current Source Formed With Bootstrapped Integrator

BY: Clayton B. Grantham, Test

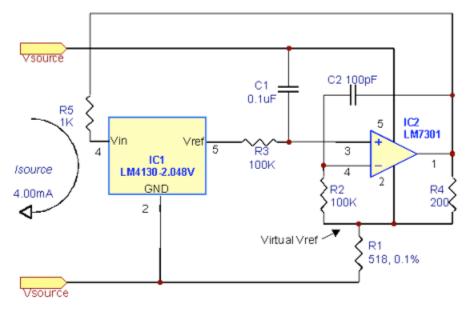


Figure 1. This composite CMOS voltage reference and OpAmp integrator forms a general-purpose current source.

The general-purpose current source in Figure 1 is accurate within 1% and insensitive to temperature (less than 50 ppm/°C). It also has a high output resistance and a wide compliance range (4.3 to 34 V). This composite configuration uses an IC voltage reference (IC1) and resistor (R1) to create a current source that follows the expression $I_{SOURCE} = V_{REE}/R1 + IC1$'s ground current.

IC1's accuracy is extended beyond its 5.5-V supply-voltage limitation (CMOS). This is achieved using a bootstrap integrator made by IC2, R2, and C2, which keeps IC1's input within compliance. Consequently, a precise current source that matches the wide supply range of IC2 is produced.

IC2 is the pass device that keeps IC1's input within compliance (below 5.5 V). With the bootstrapping of IC2, this configuration doesn't have an additional IC2 ground-current error. IC2, R2, and C2 form an integrator that forces IC1's input to keep the voltage across R1 equal to V_{RFF} . At the same time, IC2's output sources current through

R4. This current sums with IC2's negative supply current. I_{SOURCE} is generated by this current through R1 plus a small IC1 ground-current offset error (50 μ A).

The error in accurately setting I_{SOURCE} with this composite configuration is derived from three sources.

 V_{RFF} and R1 are both available in 0.1% tolerance. IC1's ground-current variation of ±7 μ A on 50 μ A translates to

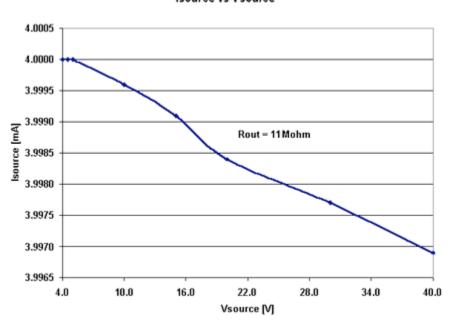
an additional 0.2% tolerance. When these tolerances are combined, the total I_{SOURCE} tolerance is under 1%.

Similarly, I_{SOURCE}'s insensitivity to temperatures from -40°C to 85°C is a function of the temperature coefficients of V_{REF}, R1, and IC1's ground current. The LM4130 is available in a 0.1% tolerance with 20 ppm/°C TC grade. Inexpensive resistors are commonly available in 0.1% tolerance with 25 ppm/°C TC grade. The LM4130's ground-current variation of $\pm 5 \ \mu$ A on 50 μ A over temperature provides an additional TC of 20 ppm/ÅC.

Therefore, the total I_{SOURCE} TC is lower than 50 ppm/°C.

C1 enables startup of the configuration from a V_{SOURCE} power-on step. With this choice of C1, the startup delay-time is 100 ms from a 5-V step. For a fast-edged V_{SOURCE}, a 1-ms startup can be obtained by using a 0.001 μ F cap for C1. R3 is used to isolate V_{REF} from the integrator during startup. R4 level-shifts IC2's output (which is IC1's input) up above V_{REF}, while R5 current limits IC1's input during startup.

IC2 was selected because of its wide supply range and input common-mode range, which includes its negative supply. The typical ground current of IC2 (0.6 mA) restricts the lowest setpoint for I_{SOURCE} . IC2's maximum output current (10 mA) limits the highest setpoint for I_{SOURCE} .



Isource vs Vsource

Figure 2. This plot of I_{SOURCE} versus V_{SOURCE} demonstrates that the composite op amp and voltage-reference current source has an output resistance of approximately 11 MW.

Figure 2 shows I_{SOURCE} versus voltage with an output resistance greater than 10 MW. The compliance voltage is from 4.3 V to 34 V. This upper margin is the maximum IC2 compliance plus V_{REF} . The lower limit is the minimum IC2 compliance plus V_{REF} .

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		
		u Hama Dawa	a O a Al a a m

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated